

L*Number	Hits	Search Text	DB	Time stamp
1	92	73/862.043.ccls.	USPAT	2003/04/25 13:41
2	243	73/826.ccls.	USPAT	2003/04/25 13:42
3	181	72/75.ccls.	USPAT	2003/04/25 13:42
4	140	72/379.6.ccls.	USPAT	2003/04/25 13:54
5	568	72/379.2.ccls.	USPAT	2003/04/25 13:55
8	74	(73/862.043.ccls. 73/826.ccls. 72/75.ccls. 72/379.6.ccls. 72/379.2.ccls.) and (tensi\$4 near4 stress\$4)	USPAT	2003/04/25 13:57
9	3329	(tensi\$4 near4 stress\$4 near4 (lower\$4 decreas\$4 minim\$4 reduc\$4 diminish\$4))	USPAT	2003/04/25 14:00
10	17	((tensi\$4 near4 stress\$4 near4 (lower\$4 decreas\$4 minim\$4 reduc\$4 diminish\$4))) same ((compress\$4 pressur\$4 forc\$4 burnish\$4) near4 (chang\$4 vari\$4 divers\$4 differ\$4 manipul\$4) near4 (surface layer film body specimen metal\$4 plate))	USPAT	2003/04/25 14:34
11	16	("1784866" "3494013" "3770595" "3820210" "4118846" "4132098" "4509351" "4565081" "4821388" "4947668" "5099558" "5329684" "5522706" "5525429" "5666841" "5826453").PN.	USPAT	2003/04/25 14:16
15	805	29/90.01.ccls.	USPAT	2003/04/25 14:33
16	12	29/90.01.ccls. and ((compress\$4 pressur\$4 forc\$4 burnish\$4) near4 (chang\$4 vari\$4 divers\$4 differ\$4 manipul\$4) near4 (surface layer film body specimen metal\$4 plate))	USPAT	2003/04/25 14:41
17	28	burnish\$4 near4 densi\$4	USPAT	2003/04/25 14:42
-	81	73/862.043.ccls.	USPAT	2003/04/25 13:41
-	235	73/826\$3.ccls.	USPAT	2001/03/30 12:31
-	79	73/826\$3.ccls. and method	USPAT	2001/04/03 16:14
-	235	73/826.ccls.	USPAT	2003/04/25 13:41
-	599	73/\$7.ccls. and method and tensile near3 stress	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:16
-	14	73/\$7.ccls. and ((method and tensile near3 stress and pressure).clm.)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:29
-	1	73/\$7.ccls. and ((method and tensile near3 stress and pressure).clm.) and cold near2 work\$2	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:19
-	0	73/\$7.ccls. and method and measure and pressure and (tensile near3 stress) and (cold near2 work\$2) and burnish\$3	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:34
-	14	73/\$7.ccls. and method and measure and pressure and (tensile near3 stress) and cold near2 work\$2	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:21
-	9	73/\$7.ccls. and method and measure and pressure and (tensile near3 (stress tension)) and (cold near2 work\$3) and (burnish\$3 rub\$3 polish\$3 smooth\$3)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:27
-	47	73/\$7.ccls. and ((method and tensile near3 stress and pressure) and (reduce lower short).clm.)	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:39
-	0	(method and measure and pressure and (tensile near3 stress) and (cold near2 work\$2) and burnish\$3).clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:37
-	1	method and measure and pressure and (tensile near3 stress) and (cold near2 work\$2) and burnish\$3	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:34

-	15	(method and measure and pressure and (tensile near3 stress) and (cold near2 work\$2) and (burnish\$3 rubbing rub smooth smoothing polish polishing))	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:43
-	1	(method and measure and (reduce lower decrease) and (tensile near3 stress) and (cold near2 work\$2) and ((burnish\$3 rubbing rub smooth smoothing polish polishing) near3 (device apparatus machine)))	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/03 16:45
-	2561	((elimina\$4 reduce\$ decreas\$4 lower\$4) and stress).ti.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 14:42
-	2070	((elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress).ti.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 14:43
-	1415	((elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress).clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 15:10
-	31	((elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress).clm.) and cold near4 work\$3	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 14:50
-	9	((elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress).clm.) and cold near4 work\$3).clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 14:51
-	308	((elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress) and (burnish\$4 polish\$4).clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 15:17
-	1	((elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress and (burnish\$4 polish\$4)and cold).clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 15:13
-	34	((elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress) and (burnish\$4 polish\$ and compress\$4).clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 15:21
-	1	(cold and(elimina\$4 reduce\$ decreas\$4 lower\$4) near4 stress and (burnish\$4 polish\$) and compress\$4).clm.	USPAT; EPO; JPO; DERWENT; IBM_TDB	2001/04/06 15:25